

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10536621			
<b>Filing Date:</b>	26-May-2005			
<b>Title of Invention:</b>	Polishing pad and method of producing semiconductor device			
<b>First Named Inventor/Applicant Name:</b>	Masahiko Nakamori			
<b>Filer:</b>	Daniel E. Altman/Hiroko Isetani			
<b>Attorney Docket Number:</b>	UNI40.005APC			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Submission- Information Disclosure Stmt	1806	1	180	180
<b>Total in USD (\$)</b>				<b>180</b>